TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

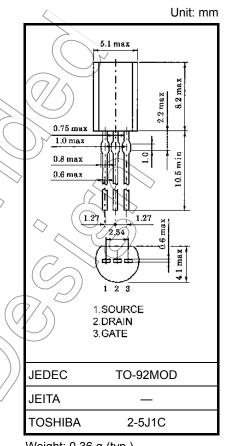
2SK3670

Chopper Regulator and DC-DC Converter Applications

- 2.5V-Gate Drive
- Low drain-source ON-resistance: R_{DS} (ON) = 1.0 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 2.1 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 150 V)
- Enhancement mode: V_{th} = 0.5 to 1.3 V (V_{DS} = 10 V, I_D =200 μ A)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	>	
Drain-source voltage		V _{DSS}	150	$\langle \psi \rangle$		
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	150	V		
Gate-source voltage		V _{GSS}	±12	v V		
Drain current	DC	(Note 1)	ID	0.67	\sim	
	Pulse (t \leq s	ōs) (Note 1)	I _{DP}		A	(
	Pulse	(Note 1)	I _{DP}	3		
Drain power dissipation			Pp	0.9	W	
Single pulse avalanche energy (Note 2)			EAS	41	m J	\geq
Avalanche current		(JAR))	0.67	A		
Repetitive avalanche energy (Note 3)			EAR	0.09	۲ m	
Channel temperature			//t _{ch}	150	℃	
Storage temperature range			T _{stg}	-55 to 150	°C	

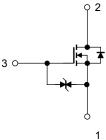


Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch-a)}	138	°C / W



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DS} = 50V, T_{ch} = 25^{\circ}C(initial), L = 135mH, I_{AR} = 0.67A, R_G = 25\Omega

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

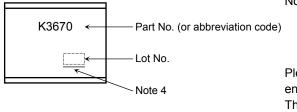
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V_{GS} = ±9.6 V, V_{DS} = 0 V	_	—	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V	_	—	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	150	—	-	V
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D =200 μ A	0.5	-	1.3	V
Drain-source ON-resistance		R _{DS (ON)}	V _{GS} = 2.5 V, I _D = 0.5 A	K)))1.1	2	Ω
			V _{GS} = 4 V, I _D = 0.5 A		1.0	1.7	32
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 0.5 A	.0	2.1		S
Input capacitance		C _{iss}			230		
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	14	_	pF
Output capacitance		C _{oss}		_	50		
Switching time	Rise time	tr	$5 V$ $I_D = 0.5 A$ OUT V_{GS}	- (16	\geq \sim	
	Turn-on time	t _{on}		N C	40) _	
	Fall time	t _f			23	_	- ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, t _W = 10 µs) –	95	_	
Total gate charg plus gate-drain)		Qg		_	4.6	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 120 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	—	2.9	—	nC
Gate-drain ("miller") Charge		Qgd		_	1.7	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)			_		0.67	А
Pulse drain reverse current (t=5s) (Note 1)	I _{DRP}	-		l	1	А
Pulse drain reverse current (Note 1)		-	-		3	А
Forward voltage (diode)	VDSF	I _{DR} = 0.5 A, V _{GS} = 0 V			-1.5	V
Reverse recovery time	trr	1 _{DR} = 1A, V _{GS} = 0V		95		ns
Reverse recovery charge		dl _{DR} / dt = 50A / µs	_	110	_	nC

Marking



Note 4: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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